

Single Phase 4.0Amp Glass passivated Bridge Rectifiers

Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Idea for printed circuit board
- ◆ Glass passivated junction chip
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed 260°C/10 seconds at terminals

Mechanical Data

Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

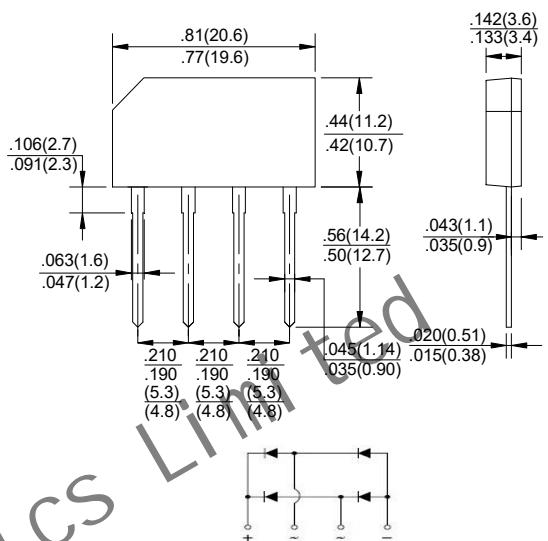
Polarity : Polarity symbol marking on body

Mounting Position : Any

GBL

RoHS
COMPLIANT

Pb
Pb-Free



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	ARDGBL 4005TX0	ARDGBL 401TX0	ARDGBL 402TX0	ARDGBL 404TX0	ARDGBL 406TX0	ARDGBL 408TX0	ARDGBL 410TX0	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current with heatsink	I _(AV)	4.0						A	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	120.0						A	
Rating for fusing (t=8.3ms, Ta=25°C)	I ² t	59.7						A ² s	
Maximum instantaneous forward voltage at 4.0A	V _F	1.10						V	
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C	I _R	2.0 200						uA	
Typical junction capacitance (Note 1)	C _J	38.0						pF	
Typical thermal resistance	R _{QA}	55.0						°C/W	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150						°C	

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

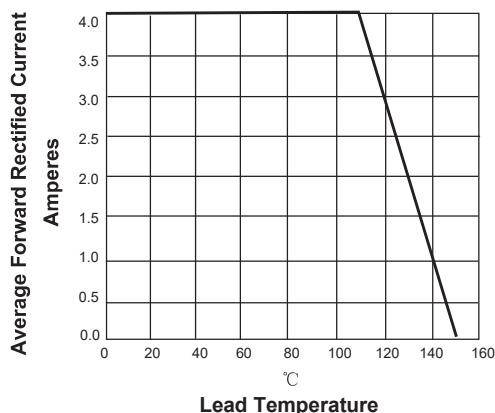


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

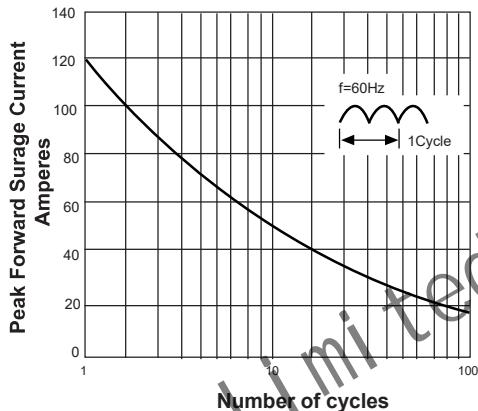


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

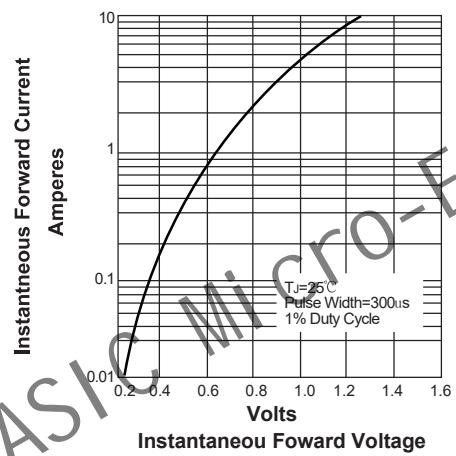
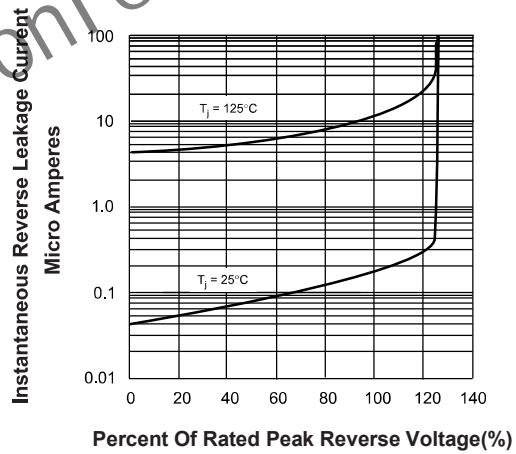
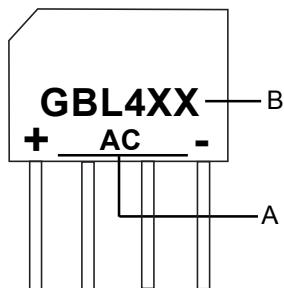


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

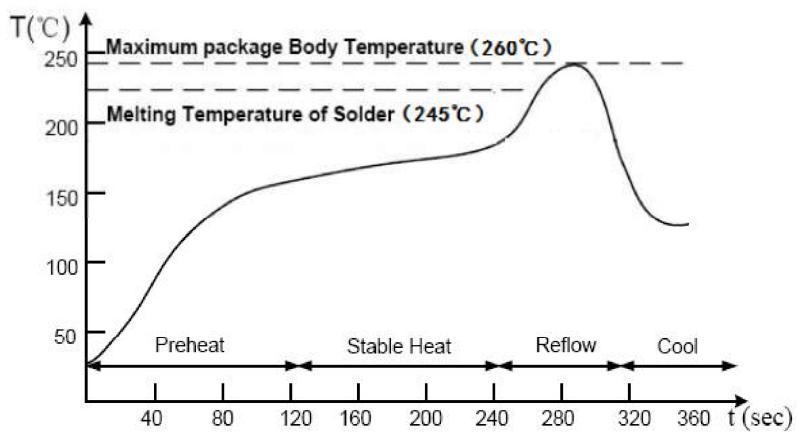


Marking



Symbol	Explanation
A	Polarity Symbol
B	Product Name, XX : 005.01.....10

Suggested Soldering Temperature Profile



Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 260°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.